

Preface

The second International Conference on Micro Nano Devices, Structure and Computing Systems (MNDSCS 2013) will be held in Shenzhen, China, from January 23 to 24, 2012. MNDSCS 2013 is sponsored by International Information Engineering Institute, USA. The aim of the conference is to provide an opportunity for experts, researchers and individuals who are interesting in Micro Nano Devices, Structure and Computing Systems to exchange their latest research progress and discuss the directions of future research of these fields, promoting the Related area development. Furthermore, at the especial invitation of the organizing committee of MNDSCS 2013, renowned scientists in the area will be present and give their keynote invited lecture.

There are 7 topics in MNDSCS 2013, including Material Science and Engineering, Nanomaterials and Nanostructure Synthesis and Properties, Nano Devices and System, Nano materials, Technologies for Applications, Circuits and Systems, Mechanical Engineering, and Industrial Electronics. And every topic consist of some secondary themes, such as Material Science and Engineering includes Composites, Micro / Nano materials, Steel and iron, Ceramic, Metal alloy materials and on. MNDSCS 2013 received hot response from participates, and they prepare extended contributions in order to allow for possibility comprehensive descriptions of the issues.

The proceedings are the result of cooperation of experts, editors and publishers. We received many manuscripts in the submission period of conference. The experts select thesis which is consistent with our conference theme and is superior in quality from numerous thesis. Then, the editors are responsible for revising of paper and communicating with the authors, and they are professional, diligent and serious. After adequate preparation, the conference proceedings will be published, and the conference will be held.

Shenzhen is a major city in the south of Southern China's Guangdong Province, situated immediately north of Hong Kong. While the city does not have as many historical attractions as other famous cities in China, it has created a number of excellent theme parks which entertain while teaching visitors about China and the world, such as window of the world, China Folk Culture Village, Happy Valley etc. In addition, it is very convenient to go to Hong Kong where you can enjoy the sites and attractions of the famous international metropolis.

We would like to express our sincerely acknowledgements to people who contribute to the proceedings and conference. We would like to thanks all the authors who submit their manuscripts, especially thank attendees come from all over the world, your support give us motivation and confidence and promote the conference successfully held. We also honestly acknowledge the individuals including our editors and other workers just because of their contribution and help, the conferences proceedings would be published on time and the conference was held successfully. Especially, our thanks are also due to the sponsors for providing much help for the conference. At last, we wish the attendees enjoy the conference and the proceedings are useful to the researchers in the fields Micro Nano Devices, Structure and Computing Systems.

Dehuai Zeng

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